ELECTRONICS CO.,I

Features

- · High Blocking Voltage with Low On-Resistance
- · High Speed Switching with Low Capacitance
- · Easy to Parallel and Simple to Drive

Benefits

- · Higher system effciency
- · Reduce cooling requirements
- · Increase power density
- · Increase system switching frequency

Applications

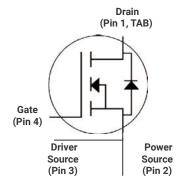
- · Renewable energy
- · EV battery chargers
- · High voltage DC/DC converters
- · Switch Mode Power Supplies

| Ordering Part Number | Package | Qty(PCS) |
|-------------------------|-----------|----------|
| SCT4036KRC15 | TO-247-4L | 30 |





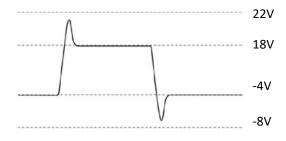




Maximum Ratings ($T_c = 25 \, ^{\circ}\text{C}$ unless otherwise specifed)

| Parameter | Symbol | Value | Unit |
|--|-----------------------------------|-----------|------|
| Drain-source voltage | Vos | 1200 | V |
| Continuous drain current | | | |
| Tc = 25°C Tc = 100°C | lσ | 117 84 | А |
| Pulsed drain current (Tc = 25°C, tp limited by T _{jmax}) | ID pulse | 250 | Α |
| Gate-Source voltage | Vgs | -4/+18 | V |
| Gate-Source voltage(dynamic,Absolute maximum values) | VGSmax | -8/+22 | V |
| Power dissipation (Tc = 25°C) | Ptot | 556 | W |
| Operating junction and storage temperature | T _j , T _{stg} | -55+175 | °C |

• Example of acceptable V_{GS} waveform



Thermal Resistance

| Parameter | Symbol | Value | Unit |
|---|--------|-------|--------|
| Thermal resistance, junction – case. Max | RthJC | 0.27 | °C/W |
| Thermal resistance, junction – ambient. Max | RthJA | 40 | J 5/VV |

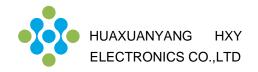
Electrical Characteristic (at Tj = 25 °C, unless otherwise specified)

| Parameter | Symbol | | Value | | Unit | Test Condition | |
|-----------------------------------|-------------|------|----------|---------|------|--|--|
| Parameter | Symbol | min. | typ. | max. | Unit | | |
| Static Characteristic | | | | | | | |
| Drain-source breakdown voltage | BVpss | 1200 | - | - | V | Vgs=0V, ID=250uA | |
| Gate threshold voltage | VGS(th) | 2 | - | 4 | V | Vps=Vgs,Ip=25mA | |
| Zero gate voltage drain current | loss | - | 1 10 | 50 - | μΑ | V _{DS} =1200V,V _{GS} =0V T _j =25°C T _j =175°C | |
| Gate-source leakage current | lgss | - | | 200 | nA | Vgs=18V,Vps=0V | |
| Drain-source on-state resistance | RDS(on) | - | 33 50 | 49 - | m | Vgs=20V, Ib=80A, Tj=25°C Tj=175°C | |
| Transconductance | G fs | - | 27 | - | S | Vps=20V,Ip=40A | |
| Dynamic Characteristic | | | | | | | |
| Input Capacitance | Ciss | - | 4508 | - | | Vps = 1000V Vgs = 0V TJ = 25°C VAC = 25mV f = 1MHz | |
| Output Capacitance | Coss | - | 214 | - | pF | | |
| Reverse Transfer Capacitance | Crss | - | 26 | - | · | | |
| Gate Total Charge | QG | - | 222 | - | | VDS = 800V VGS = -0/18V ID = 80A | |
| Gate-Source charge | Qgs | - | 46.4 | - | nC | | |
| Gate-Drain charge | Qgd | - | 77.6 | - | | | |
| Turn-On Switching Energy | Eon | - | 2290 | - | 1 | V _{DD} = 800V V _{GS} = -4/+18V I _D = 80A R _G = 5 L = 120uH | |
| Turn-Off Switching Energy- | Eoff | - | 630 | | μJ | | |
| Turn-on delay time | td(on) | - | 49.2 | - | | | |
| Rise time | tr | - | 14.2 | - | | | |
| Turn-off delay time | td(off) | - | 21.7 | - | ns | | |
| Fall time | tf | - | 11.3 | - | | | |
| Gate resistance | Rg | - | 0.9 | - | | Vac = 25mV, f=1MHz | |

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Body Diode Characteristic

| Parameter | Symbol | Value | | | Unit | Test Condition | |
|---------------------------------------|----------|-------|------|------|------|---|--|
| Farameter | Syllibol | min. | typ. | max. | Oill | rest Condition | |
| Body Diode Forward Voltage | Vsp | | 4.4 | | V | Vgs=0V,Isp=40A, T _J =25°C | |
| | VSD | | 3.9 | | | Vgs=0V,Isp=40A, Tj=175°C | |
| Body Diode Reverse Recovery Time | trr | - | 29.6 | - | ns | $V_{R} = 400V,$ $I_{D} = 80A$ $di/dt = 1000A/\mu S$ | |
| Body Diode Reverse Recovery Charge | Qrr | - | 272 | - | nC | | |



Typical Performance Characteristics

Fig 1. Output Characteristic (T_J=-55°C)

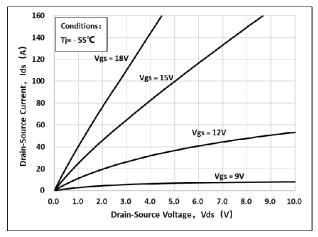


Fig 2. Output Characteristic (T_J=25℃)

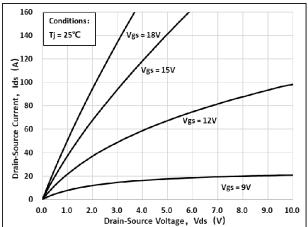


Fig 3. Output Characteristic (T_J=175℃)

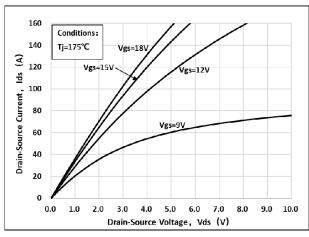


Fig 4: Rdson Vs Ids Characteristic

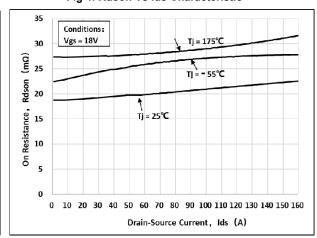


Fig 5: Rds(on) vs. Temperature

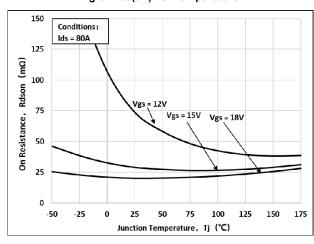


Fig 6: Transfer Characteristic

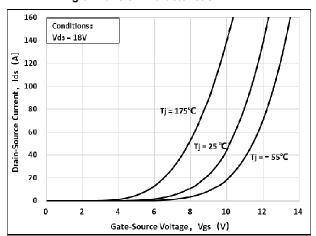




Fig 7: Body-diode Characteristic (T_J=-55°C)

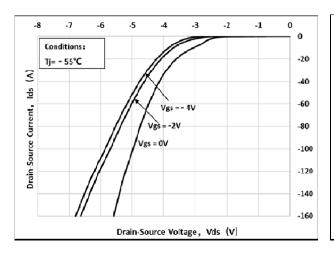


Fig 9: Body-diode Characteristic (T_J=175℃)

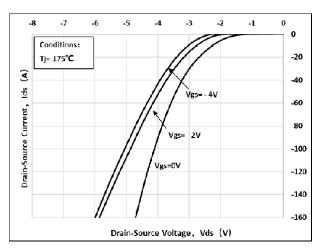


Fig 11: Gate Charge Characteristics

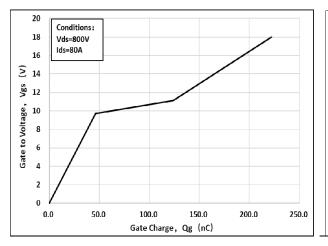


Fig 8: Body-diode Characteristic (T_J=25℃)

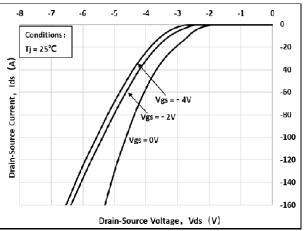


Fig 10: V_{TH} Vs T_J Temperature Characteristic

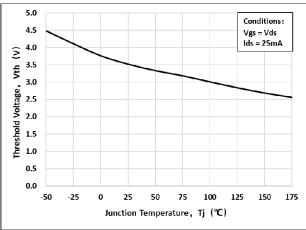
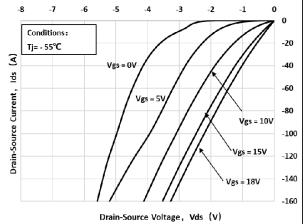


Fig 12: 3rd Quadrant Characteristic(T_J=-55°C)



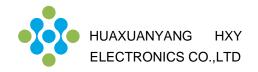


Fig 13: 3rd Quadrant Characteristic(T_J=25℃)

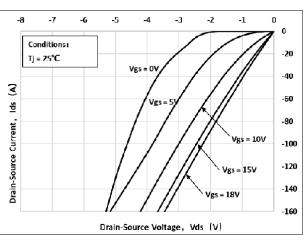
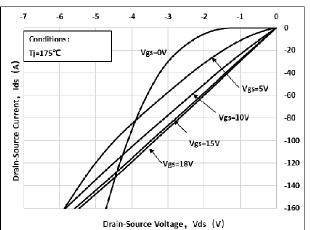
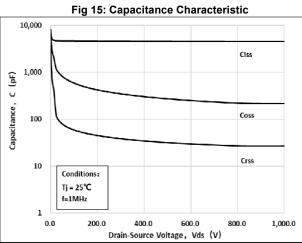
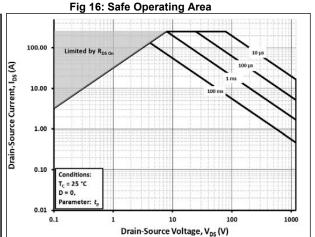
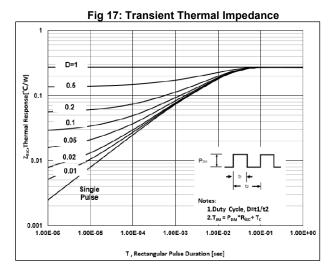


Fig 14: 3rd Quadrant Characteristic(T_J=175℃)











Test Circuit Schematic

Figure A. Definition of switching times

Figure B. Dynamic test circuit

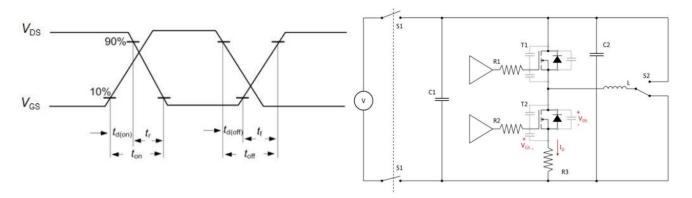


Figure C. Definition of body diodeswitching characteristics

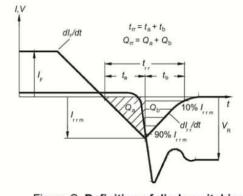
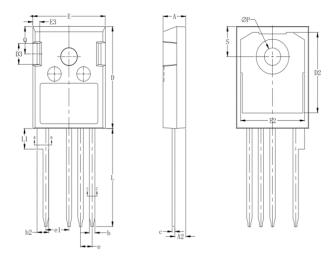


Figure C. Definition of diode switching characteristics

Package Dimensions

Package TO-247-4L



| Items | Values(mm) | | | |
|--------|------------|------|--|--|
| rteins | MIN | MAX | | |
| Α | 4.8 | 5.2 | | |
| A2 | 2.2 | 2.6 | | |
| b | 1.05 | 1.4 | | |
| b2 | 2.4 | 2.75 | | |
| С | 0.5 | 0.75 | | |
| D | 20 | 21.5 | | |
| D2 | 15.5 | 17.2 | | |
| D3 | 4 | 5 | | |
| Е | 15.5 | 16.1 | | |
| E2 | 13 | 15 | | |
| E3 | 1 | 2 | | |
| е | 2.54 BSC. | | | |
| e1 | 5.08 BSC. | | | |
| L | 19 | 21 | | |
| L1 | 4 | 4.45 | | |
| ФР | 3.5 | 3.7 | | |
| Q | 5.4 | 5.9 | | |
| S | 5.9 | 6.4 | | |



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